# International Rectifier

### IRL1404PbF

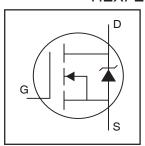
### HEXFET® Power MOSFET

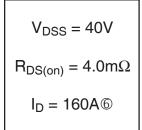
- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Lead-Free

### **Description**

Seventh Generation HEXFET® power MOSFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.







### **Absolute Maximum Ratings**

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	160®	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	110©	A
I <sub>DM</sub>	Pulsed Drain Current ①	640	
P <sub>D</sub> @T <sub>C</sub> = 25°C	Power Dissipation	200	W
	Linear Derating Factor	1.3	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>②</sup>	620	mJ
I <sub>AR</sub>	Avalanche Current①	95	А
E <sub>AR</sub>	Repetitive Avalanche Energy①	20	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns
T <sub>J</sub>	Operating Junction and	-55 to + 175	
T <sub>STG</sub>	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 srew	10 lbf•in (1.1N•m)	

### **Thermal Resistance**

	100,101011			
	Parameter	Тур.	Max.	Units
R <sub>0</sub> JC	Junction-to-Case		0.75	
R <sub>θCS</sub>	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta JA}$	Junction-to-Ambient (PCB Mounted)  ∅		62	

### International IOR Rectifier

### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	40			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.038		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance			4.0	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 95A ④
1-20(01)				5.9	11152	V <sub>GS</sub> = 4.3V, I <sub>D</sub> = 40A ⊕
V <sub>GS(th)</sub>	Gate Threshold Voltage	1.0		3.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
9fs	Forward Transconductance	93			S	$V_{DS} = 25V, I_{D} = 95A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current			20	μA	$V_{DS} = 40V$ , $V_{GS} = 0V$
.055	Jam to course Loundge Carrent			250	μ/.	$V_{DS} = 32V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
1	Gate-to-Source Forward Leakage			200	nA	V <sub>GS</sub> = 20V
I <sub>GSS</sub>	Gate-to-Source Reverse Leakage			-200	IIA	$V_{GS} = -20V$
Qg	Total Gate Charge			140		I <sub>D</sub> = 95A
Q <sub>gs</sub>	Gate-to-Source Charge			48	nC	$V_{DS} = 32V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge			60		V <sub>GS</sub> = 5.0V, See Fig. 6 ⊕
t <sub>d(on)</sub>	Turn-On Delay Time		18			$V_{DD} = 20V$
t <sub>r</sub>	Rise Time		270		ns	$I_D = 95A$
t <sub>d(off)</sub>	Turn-Off Delay Time		38			$R_G = 2.5\Omega$ $V_{GS} = 4.5V$
$t_f$	Fall Time		37			$R_D = 0.25\Omega \oplus$
L <sub>D</sub>	Internal Drain Inductance		4.5		nH	Between lead,
					ПП	6mm (0.25in.)
L <sub>S</sub>	Internal Source Inductance		7.5			from package
5						and center of die contact
C <sub>iss</sub>	Input Capacitance		6590			$V_{GS} = 0V$
Coss	Output Capacitance		1710		pF	$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		350			f = 1.0MHz, See Fig. 5
Coss	Output Capacitance		6650			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		1510			$V_{GS} = 0V, V_{DS} = 32V, f = 1.0MHz$
C <sub>oss</sub> eff.	Effective Output Capacitance ⑤		1480		1	$V_{GS} = 0V, V_{DS} = 0V \text{ to } 32V$

#### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			1000		MOSFET symbol
	(Body Diode)			160®	60® A	showing the
I <sub>SM</sub>	Pulsed Source Current			640		integral reverse
	(Body Diode) ①			640		p-n junction diode.
V <sub>SD</sub>	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C$ , $I_S = 95A$ , $V_{GS} = 0V$ ④
t <sub>rr</sub>	Reverse Recovery Time		63	94	ns	$T_J = 25^{\circ}C, I_F = 95A$
Q <sub>rr</sub>	Reverse RecoveryCharge		170	250	nC	di/dt = 100A/μs ④
t <sub>on</sub>	Forward Turn-On Time	Intr	insic tu	irn-on ti	me is ne	egligible (turn-on is dominated by L <sub>S</sub> +L <sub>D</sub> )

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11). Starting  $T_J = 25^{\circ}C$ , L = 0.35mH
- $R_G = 25\Omega$ ,  $I_{AS} = 95A$ . (See Figure 12). ③  $I_{SD} \le 95A$ ,  $di/dt \le 160A/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $T_J \le 175$ °C.
- ⓐ Pulse width ≤ 300 $\mu$ s; duty cycle ≤ 2%.
- as Coss while VDS is rising from 0 to 80% VDSS.
- © Calculated continuous current based on maximum allowable junction temperature; for recommended current-handing of the package refer to Design Tip # 93-4.
- ② Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.

# International TOR Rectifier

# IRL1404PbF

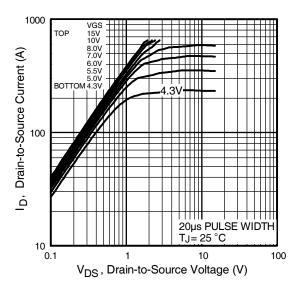


Fig 1. Typical Output Characteristics

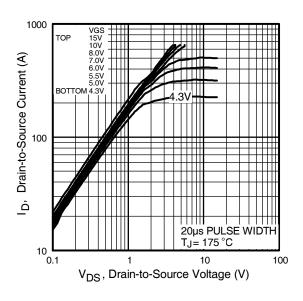


Fig 2. Typical Output Characteristics

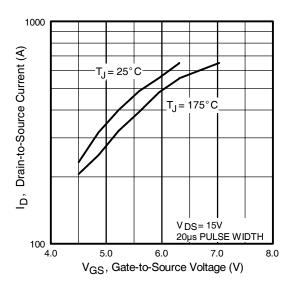
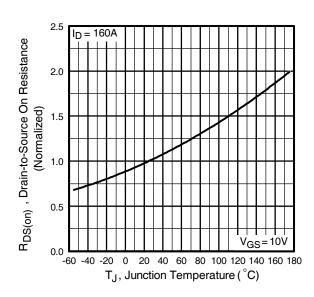
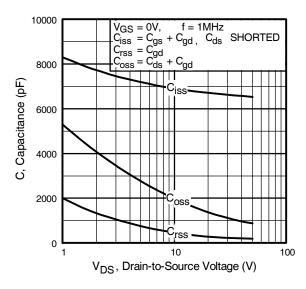


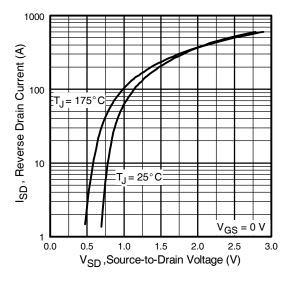
Fig 3. Typical Transfer Characteristics



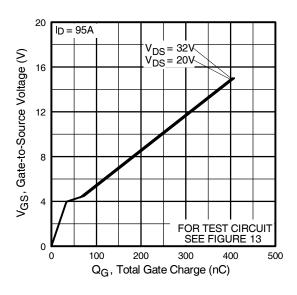
**Fig 4.** Normalized On-Resistance Vs. Temperature



**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage

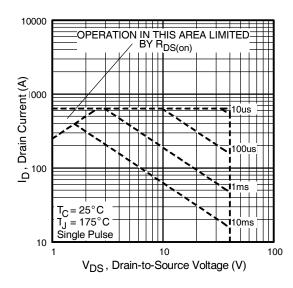
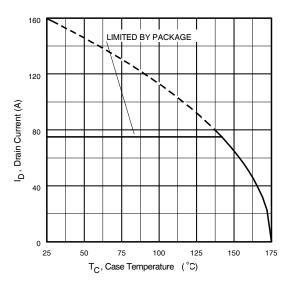


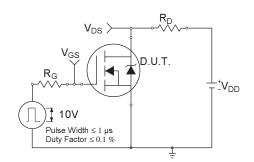
Fig 8. Maximum Safe Operating Area

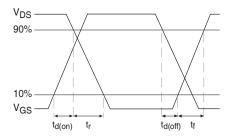
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**Fig 9.** Maximum Drain Current Vs. Case Temperature





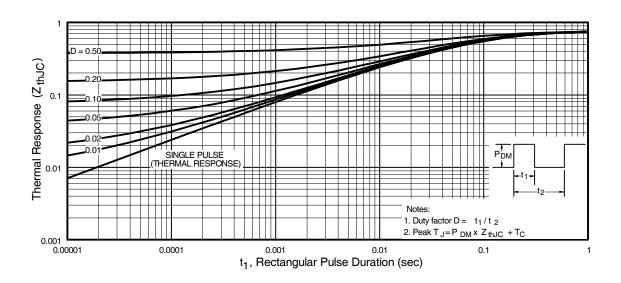


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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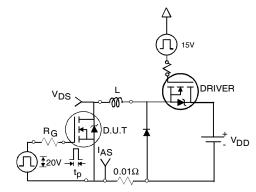


Fig 12a. Unclamped Inductive Test Circuit

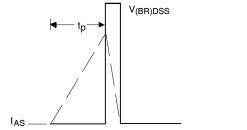


Fig 12b. Unclamped Inductive Waveforms

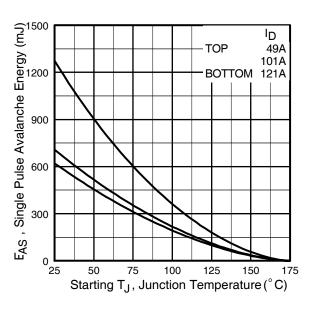


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

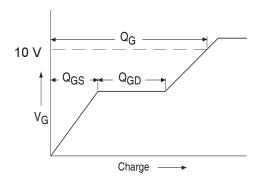


Fig 13a. Basic Gate Charge Waveform

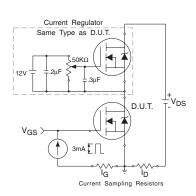
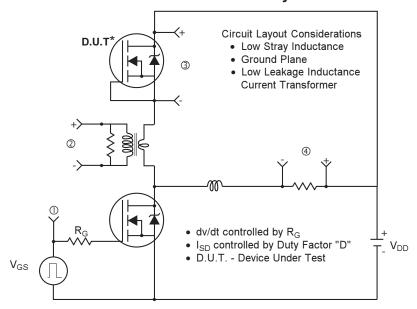
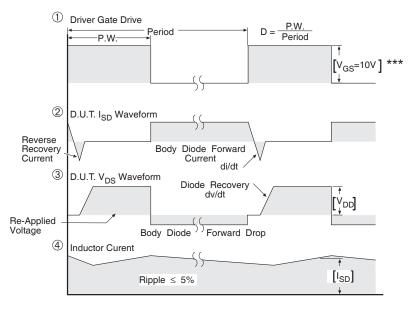


Fig 13b. Gate Charge Test Circuit

### Peak Diode Recovery dv/dt Test Circuit



\* Reverse Polarity of D.U.T for P-Channel

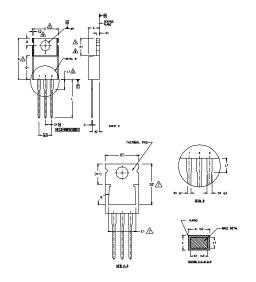


\*\*\*  $V_{GS}$  = 5.0V for Logic Level and 3V Drive Devices

Fig 14. For N-channel HEXFET® power MOSFETs

### TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



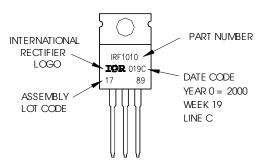
### International **I⊆R** Rectifier

	DIMENSIONS				
SAMBOL	MILLIN	ETERS	INC	INCHES	
	MN.	MAX.	Mily.	MAX.	NOTE:
A	3.56	4.82	J14D	.190	
A1	0.51	1,40	.020	,055	
A2	2,04	2.92	.080	.115	
ь	0.38	1.01	.015	.040	
ь1	0.38	0.96	.015	,038	5
b2	1,15	1,77	.045	.070	
b3	1,15	1,73	.045	.06B	
c	0.36	0,61	.014	.024	
c1	0.36	0.56	.014	.022	5
D	14,22	16.51	,560	,650	4
D1	8.38	9.02	.330	.355	
D2	12.19	12.88	.480	.507	7
E	9.66	10,66	,380	,420	4,7
E1	8.38	8.89	.330	.350	7
e	2.54 BSC		.100	1	
e1	5,08		.200	BSC	
H1	5.85	6,55	.230	.270	7,8
L	12.70	14,73	.500	.580	
L1	-	6.35	-	.250	3
øP	3,54	4,08	.139	.161	

### TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010 LOT CODE 1789 ASSEMBLED ON WW 19, 2000 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead - Free"



- 1. For an Automotive Qualified version of this part please see <a href="http://www.irf.com/product-info/auto/">http://www.irf.com/product-info/auto/</a>
- 2. For the most current drawing please refer to IR website at http://www.irf.com/package/

Data and specifications subject to change without notice. This product has been designed and qualified for the Industrial market. Qualification Standards can be found on IR's Web site.



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